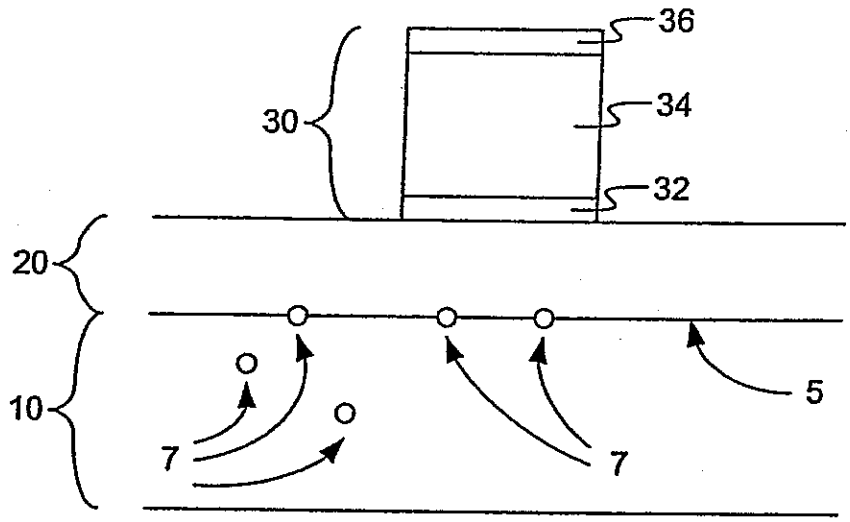


FIG. 1

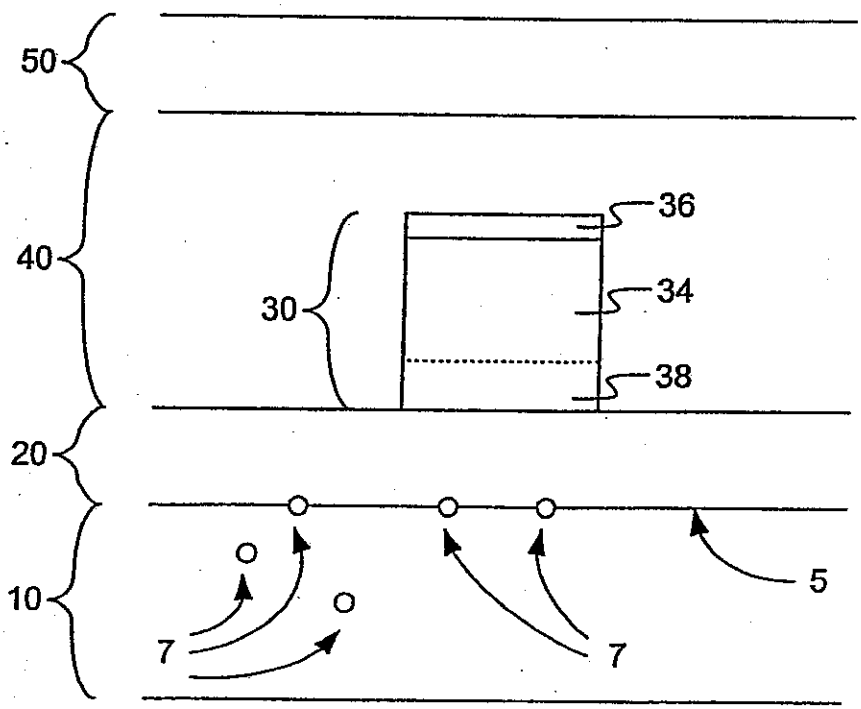


FIG. 2

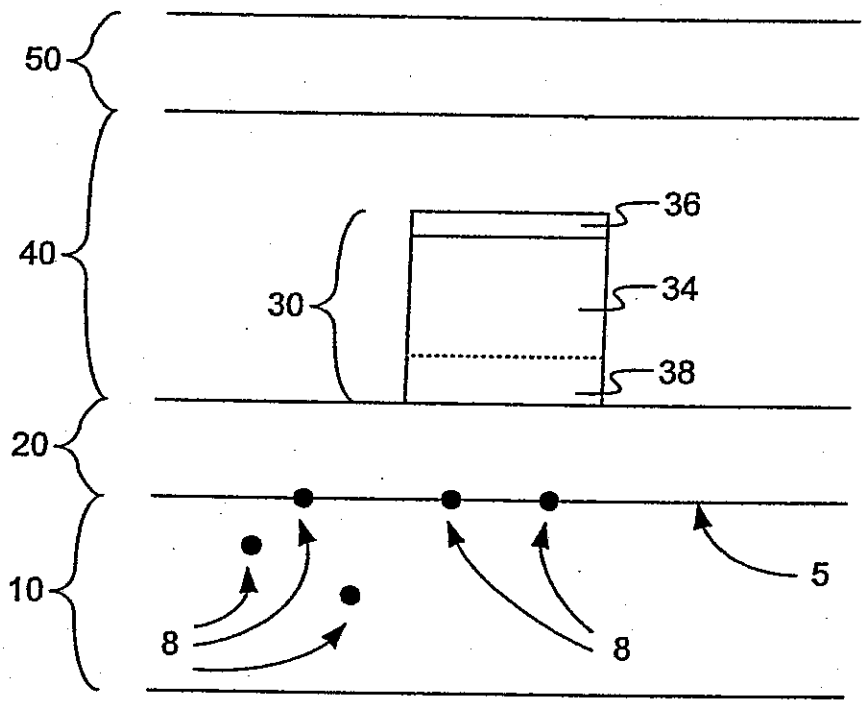


FIG. 3

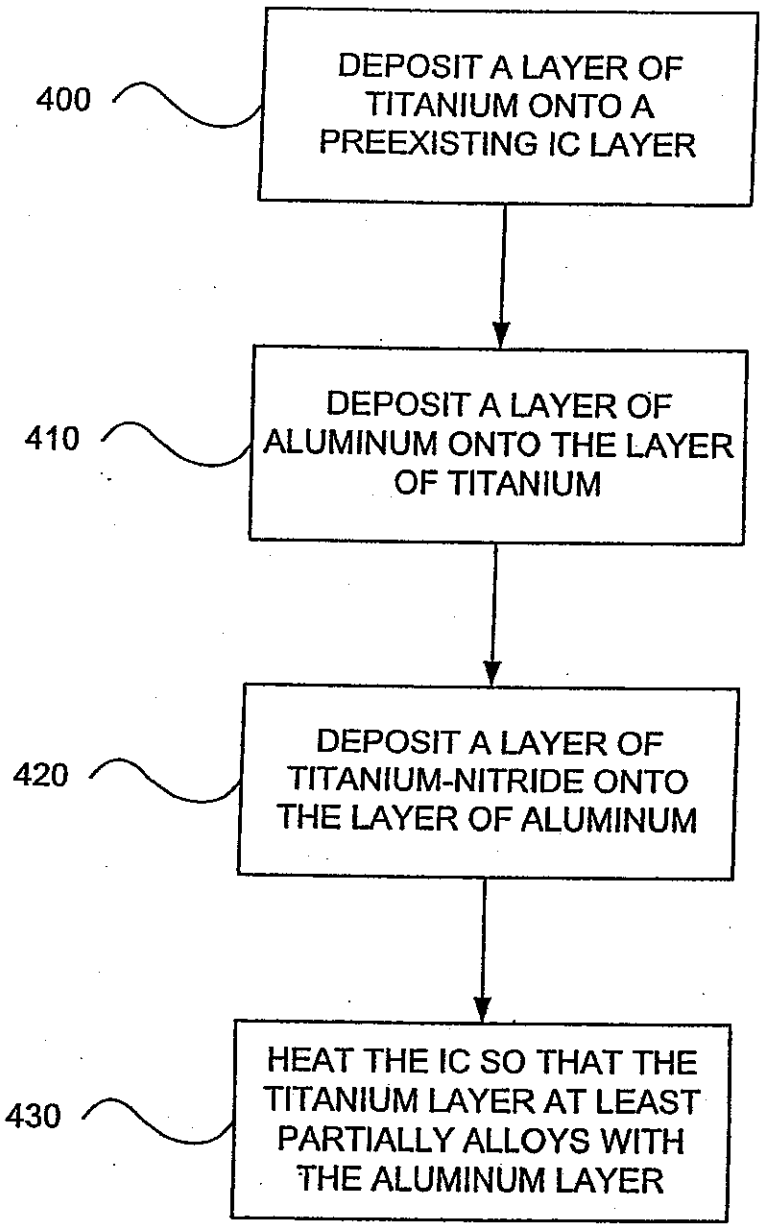

400
DEPOSIT A LAYER OF TITANIUM ONTO A PREEXISTING IC LAYER
410
DEPOSIT A LAYER OF ALUMINUM ONTO THE LAYER OF TITANIUM
420
DEPOSIT A LAYER OF TITANIUM-NITRIDE ONTO THE LAYER OF ALUMINUM
430
HEAT THE IC SO THAT THE TITANIUM LAYER AT LEAST PARTIALLY ALLOYS WITH THE ALUMINUM LAYER

FIG. 4